ON Semiconductor

Is Now



To learn more about onsemi™, please visit our website at www.onsemi.com

onsemi and ONSEMI. and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/ or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application,

MOSFET – Power, N-Channel, SUPERFET III, FRFET

650 V, 50 mΩ, 58 A

NVHL050N65S3F

Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency.

SUPERFET III FRFET MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

Features

- 700 V @ T_J = 150°C
- Typ. $R_{DS(on)} = 42 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 121 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 1119 pF)
- 100% Avalanche Tested
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

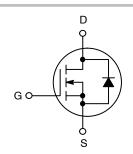
- Automotive On Board Charger HEV-EV
- Automotive DC/DC Converter HEV-EV



ON Semiconductor®

www.onsemi.com

V _{DSS}	R _{DS(ON)} MAX	I _D MAX	
650 V	50 mΩ	58 A	





TO-247 long leads CASE 340CX

MARKING DIAGRAM



\$Y = ON Semiconductor Logo &Z = Assembly Plant Code &3 = Date Code (Year & Week)

&K = Lot

NVHL050N65S3F = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS ($T_C = 25^{\circ}C$, Unless otherwise noted)

Symbol	Parameter	Value	Unit	
V _{DSS}	Drain to Source Voltage	650	V	
V _{GSS}	Gate to Source Voltage	urce Voltage – DC		V
		- AC (f > 1 Hz)	±30	-
I _D	Drain Current	– Continuous (T _C = 25°C)	58	Α
		- Continuous (T _C = 100°C)	36	-
I _{DM}	Drain Current	rain Current - Pulsed (Note 1)		Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	830	mJ	
I _{AS}	Avalanche Current (Note 2)	7.5	Α	
E _{AR}	Repetitive Avalanche Energy (Note 1)	4.03	mJ	
dv/dt	MOSFET dv/dt	100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)	50		
P_{D}	Power Dissipation	(T _C = 25°C)	403	W
		- Derate Above 25°C	3.23	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8"	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse–width limited by maximum junction temperature. 2. $I_{AS} = 7.5 \text{ A}$, $R_{G} = 25 \Omega$, starting $T_{J} = 25^{\circ}\text{C}$. 3. $I_{SD} \le 29 \text{ A}$, $di/dt \le 200 \text{ A/µs}$, $V_{DD} \le 400 \text{ V}$, starting $T_{J} = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ hetaJC}$	Thermal Resistance, Junction to Case, Max.	0.31	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
NVHL050N65S3F	NVHL050N65S3F	TO-247	Tube	N/A	N/A	30 Units

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS				1	·	
Drain-to-Source Breakdown Voltage	BV _{DSS}	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}, T_J = 25^{\circ}\text{C}$	650			V
Drain-to-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0 V, I _D = 1 mA, T _J = 150°C				V
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS} / \Delta T_{J}$	I _D = 10 mA, Referenced to 25°C		640		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 \text{ V}, V_{DS} = 650 \text{ V}$			10	μА
		$V_{DS} = 520 \text{ V}, T_{C} = 125^{\circ}\text{C}$		19		
Gate-to-Body Leakage Current	I _{GSS}	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
ON CHARACTERISTICS	,			-	•	•
Gate Threshold Voltage	V _{GS(th)}	$V_{GS} = V_{DS}, I_{D} = 1.7 \text{ mA}$	3.0		5.0	V
Threshold Temperature Coefficient	$\Delta V_{GS(th)}/\Delta T_J$	$V_{GS} = V_{DS}, I_D = 1.7 \text{ mA}$		-8		mV/°C
Static Drain-to-Source On Resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 29 \text{ A}$		42	50	mΩ
Forward Transconductance	9 _{FS}	$V_{DS} = 20 \text{ V}, I_D = 29 \text{ A}$		32.8		S
DYNAMIC CHARACTERISTICS						·
Input Capacitance	C _{iss}			5404		pF
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 400 \text{ V}, f = 1 \text{ MHz}$		110		1
Reverse Transfer Capacitance	C _{rss}			13		
Effective Output Capacitance	C _{oss(eff.)}	V _{DS} = 0 V to 400 V, V _{GS} = 0 V		1119		pF
Energy Related Output Capacitance	C _{oss(er.)}	$V_{DS} = 0 \text{ V to } 400 \text{ V}, V_{GS} = 0 \text{ V}$		198		pF
Total Gate Charge at 10 V	Q _{G(TOT)}			123		nC
Threshold Gate Charge	Q _{G(TH)}	$V_{GS} = 10 \text{ V}, V_{DS} = 400 \text{ V}, I_D = 29 \text{ A}$		22.9		
Gate-to-Source Gate Charge	Q_{GS}	(Note 4)		39.5		
Gate-to-Drain "Miller" Charge	Q_{GD}			51.4		
Equivalent Series Resistance	ESR	f = 1 MHz		1.7		Ω
SWITCHING CHARACTERISTICS			•			•
Turn-On Delay Time	t _{d(on)}			38		ns
Turn-On Rise Time	t _r	$V_{GS} = 10 \text{ V}, V_{DD} = 400 \text{ V},$		47		ns
Turn-Off Delay Time	t _{d(off)}	$I_D = 29 \text{ A}, R_g = 2.2 \Omega$ (Note 4)		87		ns
Turn-Off Fall Time	t _f			6		ns
SOURCE-DRAIN DIODE CHARACTER	ISTICS					
Maximum Continuous Source-to- Drain Diode Forward Current	I _S	V _{GS} = 0 V			58	А
Maximum Pulsed Source-to-Drain Diode Forward Current	I _{SM}	V _{GS} = 0 V			145	А
Source-to-Drain Diode Forward Voltage	V _{SD}	V _{GS} = 0 V, I _{SD} = 29 A			1.3	V
Reverse Recovery Time	t _{rr}			133		ns
Charge Time	ta	$V_{GS} = 0 \text{ V}, dI_F/dt = 100 \text{ A}/\mu \text{s},$		106		
Discharge Time	t _b	I _{SD} = 29 A		27		
Reverse Recovery Charge	Q _{rr}			603		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

TYPICAL CHARACTERISTICS

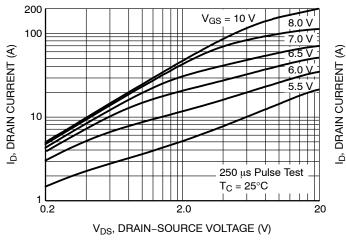


Figure 1. On-Region Characteristics

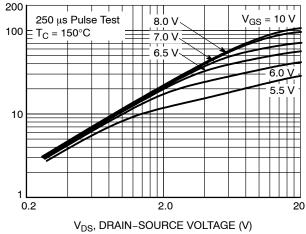


Figure 2. On-Region Characteristics

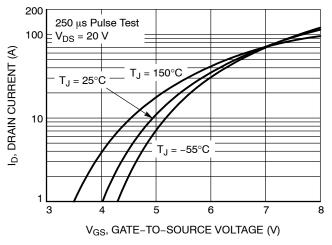


Figure 3. Transfer Characteristics

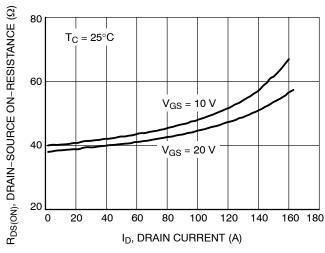


Figure 4. On-Resistance Variation vs. Drain Current and Gate Voltage

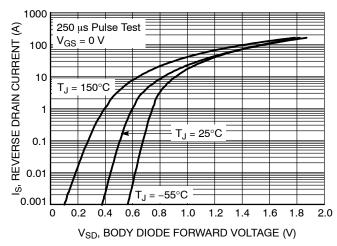


Figure 5. Body Diode Forward Voltage Variation vs. Source Current and Temperature

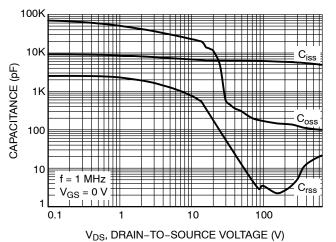
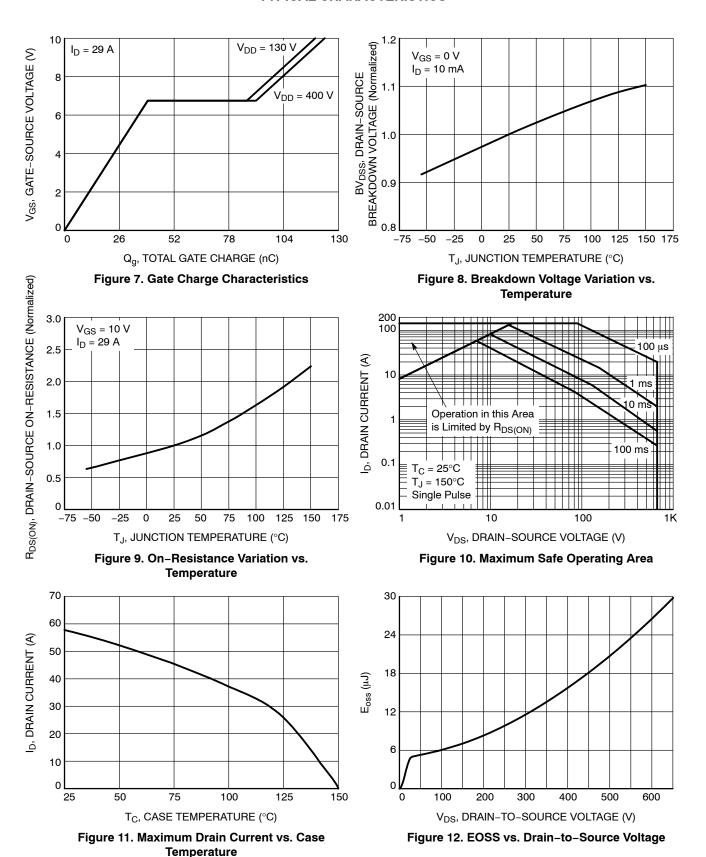


Figure 6. Capacitance Characteristics

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

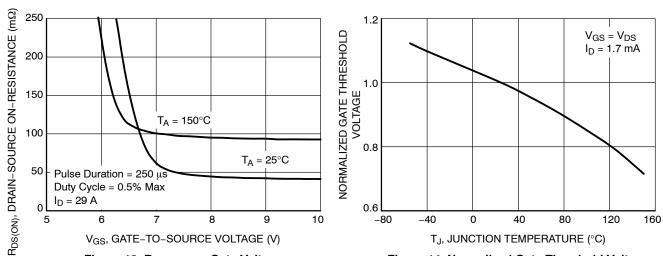


Figure 13. R_{DS(ON)} vs. Gate Voltage

Figure 14. Normalized Gate Threshold Voltage vs. Temperature

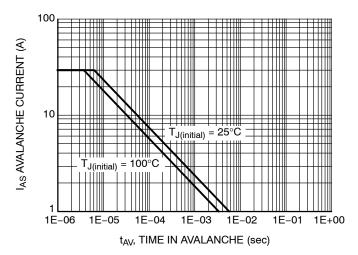


Figure 15. Unclamped Inductive Switching Capability

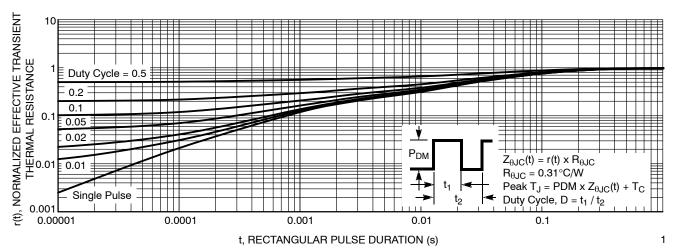
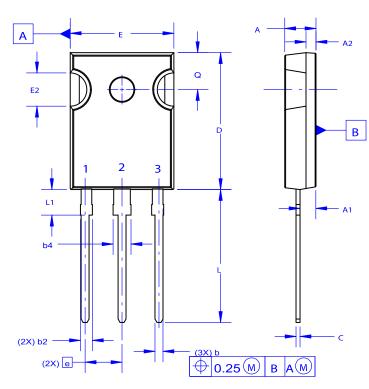


Figure 16. Transient Thermal Response Curve

SUPERFET and FRFET are registered trademarks of Semiconductor Components Industries, LLC.

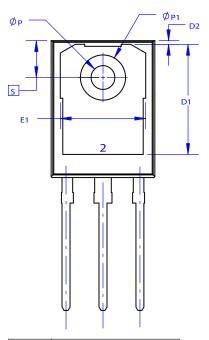
PACKAGE DIMENSIONS

TO-247-3LD CASE 340CX ISSUE O





- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.



	MILLIMETERS					
DIM	MIN	NOM	MAX			
Α	4.58	4.70	4.82			
A1	2.20	2.40	2.60			
A2	1.40	1.50	1.60			
D	20.32	20.57	20.82			
Е	15.37	15.62	15.87			
E2	4.96	5.08	5.20			
е	?	5.56	~			
L	19.75	20.00	20.25			
L1	3.69	3.81	3.93			
ØР	3.51	3.58	3.65			
Q	5.34	5.46	5.58			
S	5.34	5.46	5.58			
Ф	1.17	1.26	1.35			
b2	1.53	1.65	1.77			
b4	2.42	2.54	2.66			
С	0.51	0.61	0.71			
D1	13.08	~	~			
D2	0.51	0.93	1.35			
E1	12.81	~	~			
ØP1	6.60	6.80	7.00			

ON Semiconductor and the are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor newsers on warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemn

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Email Requests to: orderlit@onsemi.com

TECHNICAL SUPPORT
North American Technical Support:
Voice Mail: 1 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: JSA/Canada Phone: 00421 33 790 2910

ON Semiconductor Website: www.onsemi.com

Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

For additional information, please contact your local Sales Representative